



Emerging Methods in Digital Manufacturing

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Message from the Guest Editors

I would like to draw your attention to this Special Issue of JMMP. Digital manufacturing is experiencing revolutionary changes thanks to new methods such as additive manufacturing (3D printing), robotic automation, the Internet of Things (IoT), and artificial intelligence. These technologies enable the creation of more complex and personalized products with greater accuracy and efficiency. Modern approaches bring improvements in the fields of quality control, waste reduction, and optimization of production processes, thereby increasing the competitiveness and innovation potential of companies.

The scope of this Special Issue includes, but is not limited to, the following:

- Digital manufacturing;
- IoT;
- Flexible manufacturing;
- ERP systems;
- Industry 4.0;
- Sustainable manufacturing;
- AI-supported manufacturing.





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Message from the Editor-in-Chief

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